

<b>PCN Number:</b>	20170613005		<b>PCN Date:</b>	June 27, 2017													
<b>Title:</b>	Qualification of Hefei Tongfu Microelectronic Co. Ltd (HFTF) as additional Assembly and Test Site for Select Devices																
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>	<b>Dept:</b>	Quality Services														
<b>Proposed 1<sup>st</sup> Ship Date:</b>	Sept 27, 2017	<b>Estimated Sample Availability:</b>	Date provided at sample request														
<b>Change Type:</b>																	
<input checked="" type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Site												
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Material												
<input checked="" type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Bump Process												
<input type="checkbox"/>	Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Site												
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Materials												
		<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process												
<b>PCN Details</b>																	
<b>Description of Change:</b>																	
Texas Instruments is pleased to announce the Qualification of Hefei Tongfu Microelectronic Co. Ltd (HFTF) as additional Assembly and Test Site for Select Devices listed in the "Product Affected" Section. Current assembly sites and Material differences are as follows.																	
<table border="1"> <thead> <tr> <th>Assembly Site</th> <th>Assembly Site Origin</th> <th>Assembly Country Code</th> <th>Assembly Site City</th> </tr> </thead> <tbody> <tr> <td>NFME</td> <td>NFM</td> <td>CHN</td> <td>Chongchuan</td> </tr> <tr> <td><b>HFTF</b></td> <td><b>HFT</b></td> <td><b>CHN</b></td> <td><b>Hefei</b></td> </tr> </tbody> </table>						Assembly Site	Assembly Site Origin	Assembly Country Code	Assembly Site City	NFME	NFM	CHN	Chongchuan	<b>HFTF</b>	<b>HFT</b>	<b>CHN</b>	<b>Hefei</b>
Assembly Site	Assembly Site Origin	Assembly Country Code	Assembly Site City														
NFME	NFM	CHN	Chongchuan														
<b>HFTF</b>	<b>HFT</b>	<b>CHN</b>	<b>Hefei</b>														
<b>Material Differences:</b>																	
<table border="1"> <thead> <tr> <th></th> <th>NFME</th> <th>HFTF</th> </tr> </thead> <tbody> <tr> <td>Mold compound</td> <td>R-07</td> <td>R-27</td> </tr> </tbody> </table>							NFME	HFTF	Mold compound	R-07	R-27						
	NFME	HFTF															
Mold compound	R-07	R-27															
Test coverage, insertions, conditions will remain consistent with current testing and verified with test MQ.																	
<b>Reason for Change:</b>																	
Continuity of supply.																	
<b>Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):</b>																	
None																	
<b>Anticipated impact on Material Declaration</b>																	
<input type="checkbox"/>	No Impact to the Material Declaration	<input checked="" type="checkbox"/>	Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained from the <a href="#">TI Eco-Info website</a> . There is no impact to the material meeting current regulatory compliance requirements with this PCN change.														
<b>Changes to product identification resulting from this PCN:</b>																	
<table border="1"> <thead> <tr> <th>Assembly Site</th> <th>Assembly Site Origin (22L)</th> <th>ASO:</th> </tr> </thead> <tbody> <tr> <td>NFME</td> <td>Assembly Site Origin (22L)</td> <td>NFM</td> </tr> <tr> <td><b>HFTF</b></td> <td><b>Assembly Site Origin (22L)</b></td> <td><b>HFT</b></td> </tr> </tbody> </table>						Assembly Site	Assembly Site Origin (22L)	ASO:	NFME	Assembly Site Origin (22L)	NFM	<b>HFTF</b>	<b>Assembly Site Origin (22L)</b>	<b>HFT</b>			
Assembly Site	Assembly Site Origin (22L)	ASO:															
NFME	Assembly Site Origin (22L)	NFM															
<b>HFTF</b>	<b>Assembly Site Origin (22L)</b>	<b>HFT</b>															
Sample product shipping label (not actual product label)																	

TEXAS INSTRUMENTS  
MADE IN: Malaysia  
2DC: 2Q:



(1P) SN74LS07NSR  
(Q) 2000 (D) 0336  
(31T) LOT: 3959047MLA  
(4W) TKY (1T) 7523483SI2  
(P)  
(2P) REV: (V) 0033317  
(20L) CSO: SHE (21L) CCO: USA  
(22L) ASO: MLA (23L) ACO: MYS

MSL 2 /260C/1 YEAR SEAL DT  
MSL 1 /235C/UNLIM 03/29/04

OPT:  
ITEM: 39  
LBL: 5A (L)T0:1750

ASSEMBLY SITE CODES: NFME = E, HFTF = J

**Product Affected: Group 1**

SN74AHC1G00DBVR	SN74CBT1G125DBVR	SN74LVC1G240DBVT	TL432ACDBVR
SN74AHC1G00DBVT	SN74CBT1G125DBVT	SN74LVC1G32DBVR	TL432AIDBVR
SN74AHC1G02DBVR	SN74CBT1G384DBVR	SN74LVC1G32DBVT	TL432AQDBVR
SN74AHC1G02DBVT	SN74CBT1G384DBVT	SN74LVC1G34DBVR	TL432AQDBVT
SN74AHC1G04DBVR	SN74CBTD1G125DBVR	SN74LVC1G34DBVT	TL432BCDBVR
SN74AHC1G04DBVT	SN74CBTD1G125DBVT	SN74LVC1G38DBVR	TL432CDBVR
SN74AHC1G08DBVR	SN74CBTD1G384DBVR	SN74LVC1G38DBVT	TL432IDBVR
SN74AHC1G08DBVT	SN74CBTD1G384DBVT	SN74LVC1G66DBVR	TLV1391CDBVR
SN74AHC1G09DBVR	SN74CBTLV1G125DBVR	SN74LVC1G66DBVT	TLV1391CDBVT
SN74AHC1G125DBVR	SN74LV1T00DBVR	SN74LVC1G79DBVR	TLV1391IDBVR
SN74AHC1G125DBVT	SN74LV1T02DBVR	SN74LVC1G79DBVT	TLV1391IDBVT
SN74AHC1G126DBVR	SN74LV1T04DBVR	SN74LVC1G80DBVR	TLV2361CDBVR
SN74AHC1G126DBVT	SN74LV1T08DBVR	SN74LVC1G80DBVT	TLV2361CDBVT
SN74AHC1G14DBVR	SN74LV1T125DBVR	SN74LVC1G86DBVR	TLV2361IDBVR
SN74AHC1G14DBVT	SN74LV1T126DBVR	SN74LVC1G86DBVT	TLV2361IDBVT
SN74AHC1G32DBVR	SN74LV1T32DBVR	SN74LVC1GU04DBVR	TLV431BCDBVR
SN74AHC1G32DBVT	SN74LV1T34DBVR	SN74LVC1GU04DBVT	TLV431BCDBVT
SN74AHC1G86DBVR	SN74LV1T86DBVR	TL331IDBVT	TLV431BIDBVR
SN74AHC1G86DBVT	SN74LVC1G00DBVR	TL331KDBVR	TLV431BIDBVT
SN74AHC1GU04DBVR	SN74LVC1G00DBVT	TL331KDBVT	TLV431BQDBVR
SN74AHC1GU04DBVT	SN74LVC1G02DBVR	TL343IDBVR	TLV431BQDBVT
SN74AHCT1G00DBVR	SN74LVC1G02DBVT	TL343IDBVT	TLVH431ACDBVR
SN74AHCT1G00DBVT	SN74LVC1G04DBVR	TL431ACDBVR	TLVH431ACDBVT
SN74AHCT1G02DBVR	SN74LVC1G04DBVT	TL431ACDBVT	TLVH431AIDBVR
SN74AHCT1G02DBVT	SN74LVC1G06DBVR	TL431AIDBVR	TLVH431AIDBVT
SN74AHCT1G04DBVR	SN74LVC1G06DBVT	TL431AIDBVT	TLVH431AQDBVR
SN74AHCT1G04DBVT	SN74LVC1G07DBVR	TL431AQDBVR	TLVH431AQDBVT
SN74AHCT1G08DBVR	SN74LVC1G07DBVT	TL431AQDBVT	TLVH431BCDBVR
SN74AHCT1G08DBVT	SN74LVC1G08DBVR	TL431BCDBVR	TLVH431BCDBVT
SN74AHCT1G125DBVR	SN74LVC1G08DBVT	TL431BCDBVT	TLVH431BIDBVR
SN74AHCT1G125DBVT	SN74LVC1G125DBVT	TL431BIDBVR	TLVH431BIDBVT
SN74AHCT1G126DBVR	SN74LVC1G126DBVR	TL431BIDBVT	TLVH431BQDBVR
SN74AHCT1G126DBVT	SN74LVC1G126DBVT	TL431BQDBVR	TLVH431BQDBVT
SN74AHCT1G14DBVR	SN74LVC1G132DBVR	TL431BQDBVT	TLVH431CDBVR
SN74AHCT1G14DBVT	SN74LVC1G132DBVT	TL431CDBVR	TLVH431CDBVT
SN74AHCT1G32DBVR	SN74LVC1G14DBVR	TL431CDBVT	TLVH431IDBVR
SN74AHCT1G32DBVT	SN74LVC1G14DBVT	TL431IDBVR	TLVH431IDBVT
SN74AHCT1G86DBVR	SN74LVC1G17DBVR	TL431IDBVT	TLVH431QDBVR
SN74AHCT1G86DBVT	SN74LVC1G17DBVT	TL431QDBVR	TLVH431QDBVT
SN74CB3T1G125DBVR	SN74LVC1G240DBVR	TL431QDBVT	TS5A1066DBVR

**Qualification Report**  
**HFTF SOT: 5DBV Assy Site Qual**  
 Approve Date 09-Jun-2017

**Product Attributes**

Attributes	Qual Device: SN74AHC1G14DBVR	Qual Device: SN74CBTLV1G125DBVR	Qual Device: SN74LVC1G17DBVR	Qual Device: TL431AIDBVR	Qual Device: TLVH431AIDBVR
Assembly Site	NFME	NFME	NFME	NFME	NFME
Package Family	SOT-23	SOT-23	SOT-23	SOT-23	SOT-23
Flammability Rating	UL 94 V-0	UL 94 V-0	UL 94 V-0	UL 94 V-0	UL 94 V-0
Wafer Fab Supplier	SFAB	FFAB	FFAB	SFAB	SFAB
Wafer Process	EPIC1S2	ASL3C	50b10.13 BOPO	J11	J12

- QBS: Qual By Similarity
- Qual Device SN74AHC1G14DBVR is qualified at LEVEL1-260C

**Qualification Results**

Data Displayed as: Number of lots / Total sample size / Total failed

Type	Test Name / Condition	Duration	Qual Device: SN74AHC1G14DBVR	Qual Device: SN74CBTLV1G125DBVR	Qual Device: SN74LVC1G17DBVR
AC	Autoclave 121C	96 Hours	3/231/0	3/231/0	3/231/0
AC	Autoclave 121C	144 Hours	3/231/0	3/231/0	3/231/0
FLAM	Flammability (IEC 695-2-2)	--	3/15/0	-	-
FLAM	Flammability (UL 94V-0)	--	3/15/0	-	-
FLAM	Flammability (UL-1694)	--	3/15/0	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	3/231/0	3/231/0
HAST	Biased HAST, 130C/85%RH	192 Hours	3/231/0	3/231/0	3/231/0
HTOL	Life Test, 150C	300 Hours	3/231/0	3/231/0	3/231/0
HTSL	High Temp. Storage Bake, 170C	400 Hours	3/231/0	3/231/0	3/231/0
HTSL	High Temp. Storage Bake, 170C	600 Hours	3/231/0	3/231/0	3/231/0
LI	Lead Fatigue	Leads	3/66/0	-	-
LFA	Lead Finish Adhesion	Leads	3/45/0	-	-
LI	Lead Pull to Destruction	Leads	3/66/0	-	-
PD	Physical Dimensions	--	3/15/0	-	-
SD	Solderability	Pb	3/66/0	-	-

SD	Solderability	Pb Free	3/66/0	-	-
TC	Temperature Cycle, -65/150C	500 Cycles	3/231/0	3/231/0	3/231/0
TC	Temperature Cycle, -65/150C	750 Cycles	3/231/0	3/231/0	3/231/0
DSS	Die Shear	Die	3/30/0	3/30/0	3/30/0
WBP	Bond Pull	Wires	3/228/0	3/228/0	3/228/0
WBS	Ball Bond Shear	Wires	3/228/0	3/228/0	3/228/0
MSL	Moisture Sensitivity Level	1-260C	3/36/0	-	-
SA	Salt Atmosphere	24 Hours	3/66/0	-	-
XR	X-Ray	(top side only)	3/15/0	3/15/0	3/15/0

Type	Test Name / Condition	Duration	Qual Device: TL431AIDBVR	Qual Device: TLVH431AIDBVR
AC	Autoclave 121C	96 Hours	2/154/0	1/77/0
AC	Autoclave 121C	144 Hours	2/154/0	1/77/0
FLAM	Flammability (IEC 695-2-2)	--	-	-
FLAM	Flammability (UL 94V-0)	--	-	-
FLAM	Flammability (UL-1694)	--	-	-
HAST	Biased HAST, 130C/85%RH	96 Hours	2/154/0	1/77/0
HAST	Biased HAST, 130C/85%RH	192 Hours	2/154/0	1/77/0
HTOL	Life Test, 150C	300 Hours	2/154/0	1/77/0
HTSL	High Temp. Storage Bake, 170C	400 Hours	2/154/0	1/77/0
HTSL	High Temp. Storage Bake, 170C	600 Hours	2/154/0	1/77/0
LI	Lead Fatigue	Leads	2/44/0	1/22/0
LFA	Lead Finish Adhesion	Leads	2/30/0	1/15/0
LI	Lead Pull to Destruction	Leads	2/44/0	1/22/0
PD	Physical Dimensions	--	2/10/0	1/5/0
SD	Solderability	Pb	2/44/0	1/22/0
SD	Solderability	Pb Free	2/44/0	1/22/0
TC	Temperature Cycle, -65/150C	500 Cycles	2/154/0	1/77/0
TC	Temperature Cycle, -65/150C	750 Cycles	2/154/0	1/77/0
DSS	Die Shear	Die	2/20/0	1/10/0
WBP	Bond Pull	Wires	2/152/0	1/76/0
WBS	Ball Bond Shear	Wires	2/152/0	1/76/0
MSL	Moisture Sensitivity Level	1-260C	2/24/0	1/12/0
SA	Salt Atmosphere	24 Hours	-	-
XR	X-Ray	(top side only)	2/10/0	1/5/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: <http://www.ti.com/>

**Green/Pb-free Status:**

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>